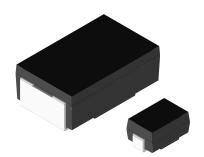
COMPLIANT

Document Number: 30162



# Metal Film Resistors, High Precision, High Stability, Surface Mount



### **FEATURES**

- Extremely low temperature coefficient or resistance
- Molded encapsulation
- Wraparound compliant terminations eliminate the risk of solder fillet cracking
- Solderable terminations
- Excellent stability at different environmental conditions
- For axial-leaded product, see Vishay Dale's PTF datasheet (<a href="https://www.vishay.com/doc?31019">www.vishay.com/doc?31019</a>)
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

STANDARD ELECTRICAL SPECIFICATIONS							
GLOBAL MODEL	SIZE	POWER RATING P <sub>85°C</sub> W	MAXIMUM WORKING VOLTAGE <sup>(1)</sup> V <sub>DC</sub>	TEMPERATURE COEFFICIENT ± ppm/°C	TOLERANCE ± %	$\begin{array}{c} \text{RESISTANCE} \\ \text{RANGE} \\ \Omega \end{array}$	ENCAPSULATION
PSF2012	2012	0.125	200	5, 10, 15, 25	0.01, 0.02, 0.05, 0.1, 0.25, 0.5, 1	15 to 100K	Ероху
PSF4527	4527	0.25	300	5, 10, 15, 25	0.01, 0.02, 0.05, 0.1, 0.25, 0.5, 1	15 to 500K	Thermoplastic

#### Notes

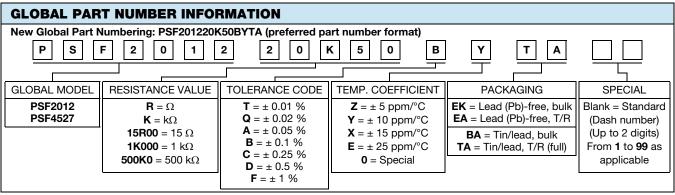
- Marking: Print-marked-model, value, tolerance, TC, date code.
- DSCC has created a drawing to support the need for a precision 2012-sized product. Vishay Dale is listed as a resource on this drawing as follows:.

DSCC DRAWING NUMBER	VISHAY DALE MODEL	POWER RATING  P <sub>85 °C</sub> W	RESISTANCE RANGE $\Omega$	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C	MAX. WORKING VOLTAGE <sup>(1)</sup> V <sub>DC</sub>
02001	PSF20121	0.125	15 to 100 K	0.01, 0.02, 0.05, 0.1, 0.25, 0.5, 1	5, 10	200

This drawing can be reviewed at: <a href="www.landandmaritime.dla.mil/Programs/MilSpec/ListDwgs.aspx?DocTYPE=DSCCdwg">www.landandmaritime.dla.mil/Programs/MilSpec/ListDwgs.aspx?DocTYPE=DSCCdwg</a>.

Continuous working voltage shall be  $\sqrt{P \times R}$  or maximum working voltage, whichever is less.

TECHNICAL SPECIFICATIONS					
PARAMETER	UNIT	PSF2012	PSF4527		
Rated dissipation at 85 °C	W	0.125	0.25		
Limiting element voltage	V≅	200	300		
Insulation voltage (1 min)	V <sub>eff</sub>	>	500		
Thermal resistance	K/W	< 1300	< 520		
Insulation resistance	Ω	<u>&gt;</u>	10 <sup>11</sup>		
Category temperature range	°C	- 55 to + 150			
Failure rate	10 <sup>-9</sup> /h	<1			
Weight/1000 pieces (typical)	g	90 760			

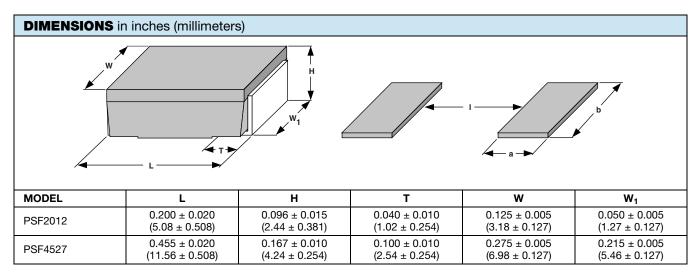


### Note

Revision: 13-Jul-12

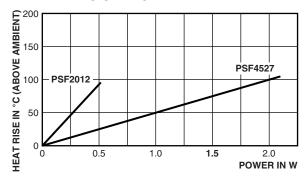
For additional information on packaging, refer to the Surface Mount Resistor Packaging document (<u>www.vishay.com/doc?31543</u>).



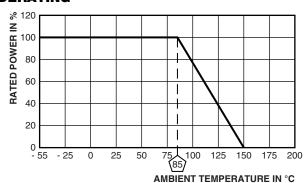


SOLDER PAD DIMENSIONS in inches (millimeters)					
MODEL	Α	В	L		
PSF2012	0.085 (2.16)	0.070 (1.78)	0.080 (2.03)		
PSF4527	0.155 (3.94)	0.230 (5.94)	0.205 (5.21)		

## THERMAL RESISTANCE



## **DERATING**



MATERIAL SPECIFICATIONS				
Element	Precision deposited nickel chrome alloy with controlled annealing			
Encapsulation	Molded epoxy on the 2012 and molded thermoplastic on the 4527			
Core	Fire-cleaned high purity ceramic			
Termination Standard leadframe material is solder-coated copper on the 2012 and solder-coated bronze on the 4527				

PACKAGING					
REEL					
MODEL	TAPE WIDTH	DIAMETER	PIECES/REEL	PACKAGING CODE	
	TAPE WIDTH			LEAD (Pb)-FREE	LEAD (Pb)-BEARING
PSF2012	12 mm/embossed plastic	330 mm/13"	2000	EA	TA
PSF4527	24 mm/embossed plastic	330 mm/13"	1200	EA	TA

### Note

• Embossed carrier tape per EIA-481.



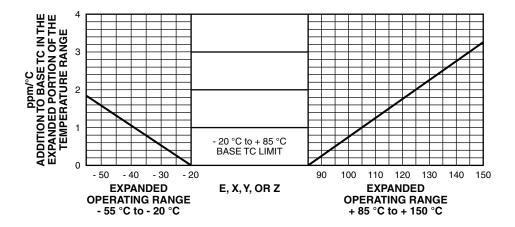
### **TEMPERATURE COEFFICIENT OF RESISTANCE**

Temperature coefficient (TC) of resistance is normally stated as the maximum amount of resistance change from the original + 25 °C value as the ambient temperature increases or decreases. This is most commonly expressed in parts per million per degree centigrade (ppm/°C).

The resistance curve over the operating temperature range is usually a non-linear curve within predictable maximum limits. PSF resistors have a very uniform resistance temperature characteristic when measured over the operating range of - 20 °C to + 85 °C. The standard temperature coefficients available are

$$E = \pm 25 \text{ ppm/°C}, X = \pm 15 \text{ ppm/°C}, Y = \pm 10 \text{ ppm/°C}, and Z = \pm 5 \text{ ppm/°C}.$$

Some applications of the PSF require operation beyond the specifications of - 20 °C to + 85 °C. The change in temperature coefficient of resistance is very small (less than  $\pm$  0.05 ppm/°C) over the expanded temperature range of - 55 °C to + 150 °C. Therefore, when operating outside the range of - 20 °C to + 85 °C, the designer can plan for a worst case addition of  $\pm$  0.05 ppm/°C for each degree centigrade beyond either - 20 °C or + 85 °C as indicated in the graph. This applies to all four temperature coefficient codes.



#### **Example:**

Assume the operating characteristics demand a temperature range from - 55 °C to + 125 °C. This requires a  $\pm$  35 °C  $\Delta$  below - 20 °C and a  $\pm$  40 °C  $\Delta$  above + 85 °C. The extreme  $\Delta$  being  $\pm$  40 °C means that the worst case addition to the specified TC limit of  $\pm$  0.05 ppm/°C times  $\pm$  40 °C or  $\pm$  2 ppm/°C. Therefore, a Z which is characterized by a base TC limit of  $\pm$  5 ppm/°C over the temperature range of - 20 °C to + 85 °C will exhibit a maximum temperature coefficient of  $\pm$  7 ppm/°C over the expanded portion of the temperature range of - 55 °C to 125 °C.

PERFORMANCE					
TEST	CONDITIONS OF TEST	TEST RESULTS (TYPICAL TEST LOTS)			
Life	MIL-STD-202, method 108, 1000 h rated power at + 85 °C	≤ ± 0.04 %			
Short time overload	MIL-PRF-55342, paragraph 4.8.6	≤ ± 0.01 %			
Thermal shock	MIL-STD-202, method 107, - 65 °C to + 150 °C	≤ ± 0.02 %			
Low temperature operation	MIL-PRF-55342, paragraph 4.8.5	≤ ± 0.02 %			
Resistance to bonding exposure	MIL-STD-202, method 210	≤ ± 0.02 %			
Moisture resistance	MIL-PRF-55342, paragraph 4.8.9	≤ ± 0.08 %			
Solder mounting integrity	MIL-PRF-55342, paragraph 4.8.13, 3 kg for 30 s	No evidence of mechanical damage			
Dielectric withstanding voltage	MIL-STD-202, methods 301 and 105	≤ ± 0.01 %			
Solderability	MIL-STD-202, method 208	95 % coverage			



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Vishay

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